

4/05/05

04-15-2005

FORM PTO-1595

RI

(Rev. 10/02)

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office**Docket No.: 071971-0180****102982090**

and original documents or copy thereto:

To the Honorable Commissioner for Patents

1. Name of Conveying Party(ies):

Hideo NAKAGAWA, Masaru SASAGO, Yoshihiko HIRAI

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ OtherExecution Date: March 22, 2005, March 22, 2005,
March 22, 2005

2. Name and address of receiving party(ies):

Name: MATSUSHITA ELECTRIC INDUSTRIAL CO.,
LTD.Address: 1006, Oaza Kadoma,
Kadoma-shi,
Osaka 571-8501 JAPANAdditional name(s) & address(es) attached? ☐ Yes ☐ No

4. Application number(s) or patent number(s):

If the document is being filed together with a new application, the execution date of the application is: March 22, 2005,
March 22, 2005,
March 22, 2005

A. Patent Application No(s).

B. Patent No(s).

Additional numbers attached? ☐ Yes ☐ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL & EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)

\$40.00

☐ Enclosed☒ Authorized to be charged to deposit account

8. Deposit account number:

500417

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Michael E. Fogarty, 36,139

April 5, 2005

Name and Registration No. of Person Signing

Signature

Date

04/14/2005 DBYRNE 00000272 500417 11098371

Total number of pages including cover sheet: 3

01 04/02/05 No. 0651-0627 (Exp. 6/30/2005)

PATENT
REEL: 016453 FRAME: 0900

Attorney Docket No. _____

ASSIGNMENT

WHEREAS, Hideo NAKAGAWA, Masaru SASAGO and Yoshihiko HIRAI
 (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements
 in PATTERN FORMATION METHOD AND
METHOD FOR FORMING SEMICONDUCTOR DEVICE
 _____ for which the undersigned has (have):

- (a) filed an application for Letters Patent of the United States of America on
 _____ having Serial No. _____; or
- (b) executed an application for Letters Patent of the United States of America on the date(s)
 indicated below; and

WHEREAS, Matsushita Electric Industrial Co., Ltd. of
1006, Oaza Kadoma, Kadoma-shi, Osaka 571-8501, Japan
 its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is
 desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters
 Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in
 hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the
 undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer
 unto the Assignee the full and exclusive right to the said invention in the United States of America and
 its territories and for all foreign countries, dependencies and possessions and the entire right, title and
 interest in and to the application and any and all Letters Patent(s) which may be granted therefor in the
 United States of America and its territories, dependencies and possessions, and in and to any and all
 divisions, reissues, continuations and extensions thereof for the full term or terms for which the same
 may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application
 and any continuing, divisional or reissue applications thereof and also to execute separate assignments
 in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference
 which may be declared concerning this application or any continuation, division or reissue thereof or
 Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way
 possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which
 may be necessary in connection with claims under or provisions of the International Convention for the
 Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to the Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

This Assignment has been executed by the undersigned on the date(s) indicated.

Date: March 22, 2005,

Hideo Nakagawa
Hideo NAKAGAWA

Date: March 22, 2005,

Masaru Sasago
Masaru SASAGO

Date: March 22, 2005,

Yoshihiko Hirai
Yoshihiko HIRAI

Date: _____,

Date: _____,

Date: _____,

Date: _____,

Date: _____,
